

# **Product Change Notification - LIAL-09YRLG884**

Date:

22 Aug 2019

**Product Category:** 

Others; 32-bit Microcontrollers; Touchscreen Controllers

**Affected CPNs:** 



## **Notification subject:**

CCCB 3498 Final Notice: Qualification of MMT as an additional assembly site for selected Atmel products of 66.11K, 66.15K, 66.26K wafer technology available in 100L TQFP (14x14x1mm) package.

**Notification text:** 

### **PCN Status:**

Final notification.

#### **PCN Type:**

Manufacturing Change

## **Microchip Parts Affected:**

Please open one of the icons found in the Affected CPNs section above.

**NOTE:** For your convenience Microchip includes identical files in two formats (.pdf and .xls)

# **Description of Change:**

Qualification of MMT as an additional assembly site for selected Atmel products of 66.11K, 66.15K, 66.26K wafer technology available in 100L TQFP (14x14x1mm) package.

# **Pre Change:**

Assembled at ASE using PdCu or CuPdAu wire, CRM-1076WA die attach and G631H mold compound material.

#### **Post Change:**

Assembled at ASE using PdCu or CuPdAu wire, CRM-1076WA die attach and G631H mold compound material or Assembled at MMT using CuPdAu wire, 3280 die attach and G700HA mold compound material.

# **Pre and Post Change Summary:**

	Pre C	hange				
Assembly Site	ASE Inc. Ta	niwan (ASE)	ASE Inc. Ta	aiwan (ASE)	Microchip Technology Thailand Branch (MMT)	
Wire material	PdCu	CuPdAu	PdCu	CuPdAu	CuPdAu	
Die attach material	CRM-1	076WA	CRM-1	3280		



Molding compound material	G631H	G631H	G700HA						
Lead frame material	C7025	C7025							
Tray Packing	No change								
Tape and Reel Packing	No change								

## **Impacts to Data Sheet:**

None

#### **Change Impact:**

None.

## **Reason for Change:**

To improve on-time delivery performance by qualifying MMT as an additional assembly site

## **Change Implementation Status:**

In Progress

#### **Estimated First Ship Date:**

October 07, 2019 (date code: 1941)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

## **Time Table Summary:**

	August 2018			>	August 2019				>	October 2019							
Workweek	31	32	33	34	35	>	31	32	33	34	35	>	40	41	42	43	44
Initial PCN Issue				Х													
Date				^													
Qual Report										Х							
Availability										^							
Final PCN Issue										Х							
Date										^							
Estimated																	
Implementation														Χ			
Date																	

## Method to Identify Change:

Traceability code

## **Qualification Report:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual Report.

### **Revision History:**

August 20, 2018: Issued initial notification.

**December 6, 2018:** Re-issued initial notification to update qualification plan with changes to preconditioning from MSL 1 / MSL 2 to MSL 3.

**July 04, 2019:** Re-issued initial notification to add additional information in the pre and post change field to include tray packing pre and post change and to update the qualification plan to add additional information in the pre-conditioning.

July 15, 2019: Re-issued initial notification to update the date in the estimated qualification



completion and time table summary.

**August 22, 2019:** Issued final notification. Attached the qualification report. Provided estimated first ship date to be on October 07, 2019. Updated the affected CPN list. Removed tray packing change in the pre and post change because there is no change in the tray packing. Updated the qualification report to update the pre-conditioning from MSL 1 or MSL 3 to MSL 3.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

#### Attachment(s):

PCN LIAL-09YRLG884 QUAL REPORT.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

#### **Terms and Conditions:**

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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#### Affected Catalog Part Numbers (CPN)

ATMXT225T-AB

ATMXT225T-ABR

ATMXT225T-AT

ATMXT225T-ATR

ATMXT225TD-AB

ATMXT225TD-ABR

ATMXT225TD-AT

ATMXT225TD-ATR

ATMXT449T-AB

ATMXT449T-AB074

ATMXT449T-ABR

ATMXT449T-ABR074

ATMXT449T-AT

ATMXT449T-AT074

ATMXT449T-ATNBI

ATMXT449T-ATR

ATMXT449T-ATR074

ATMXT449T-ATRNBI

ATMXT449TD-AB

ATMXT449TD-ABR

ATMXT449TD-AT

ATMXT449TD-ATR

ATMXT641T-AB

ATMXT641T-AB074

ATMXT641T-ABR

ATMXT641T-ABR074

ATMXT641T-AT

ATMXT641T-AT074

ATMXT641T-ATNBI

ATMXT641T-ATR

ATMXT641T-ATR074

ATMXT641T-ATRNBI

ATMXT641TC01-ATR

ATMXT641TD-AB

ATMXT641TD-ABR

ATMXT641TD-AT

ATMXT641TD-ATR

ATSAMC20N17A-ANT

ATSAMC20N18A-ANT

ATSAMC21N17A-ANT

ATSAMC21N18A-ANT

ATSAML22N16A-AUT

ATSAML22N17A-AUT

ATSAML22N18A-AUT

Date: Thursday, August 22, 2019